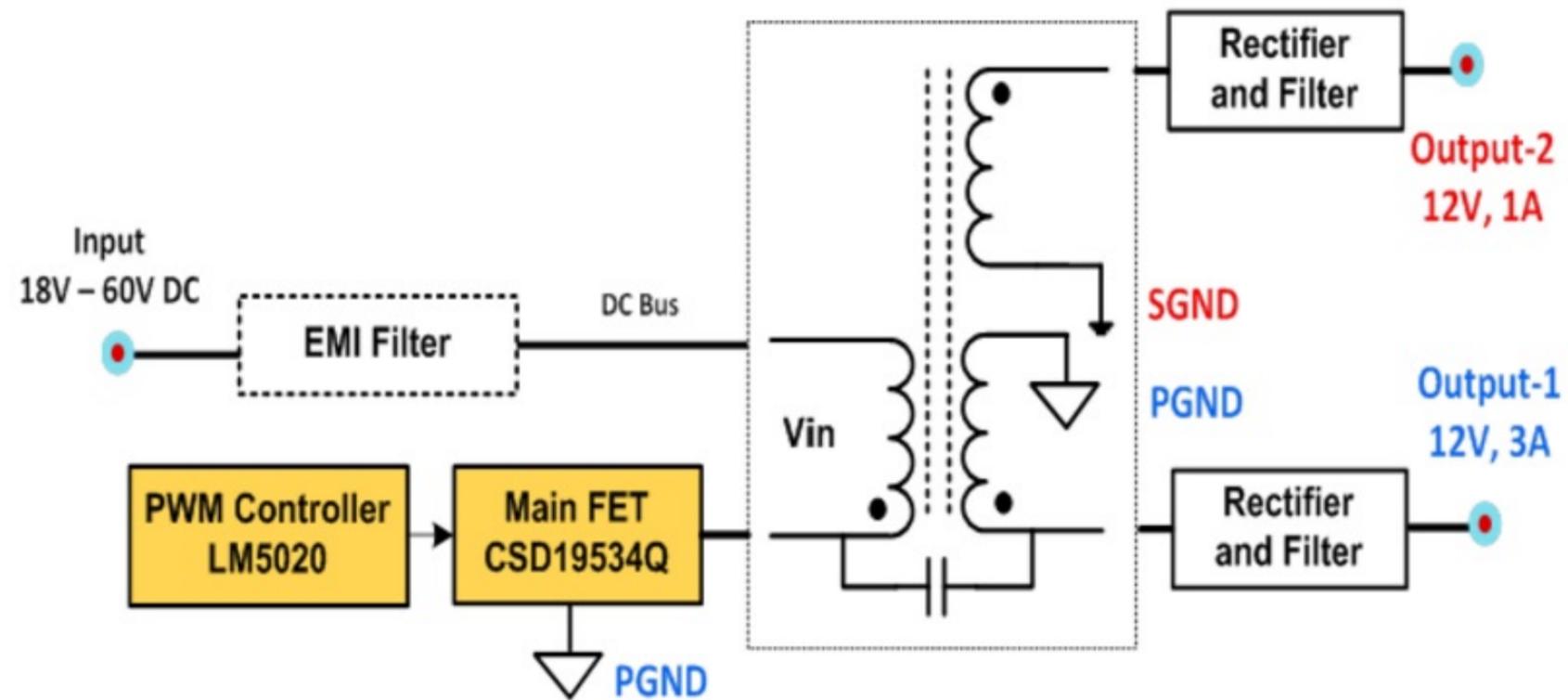


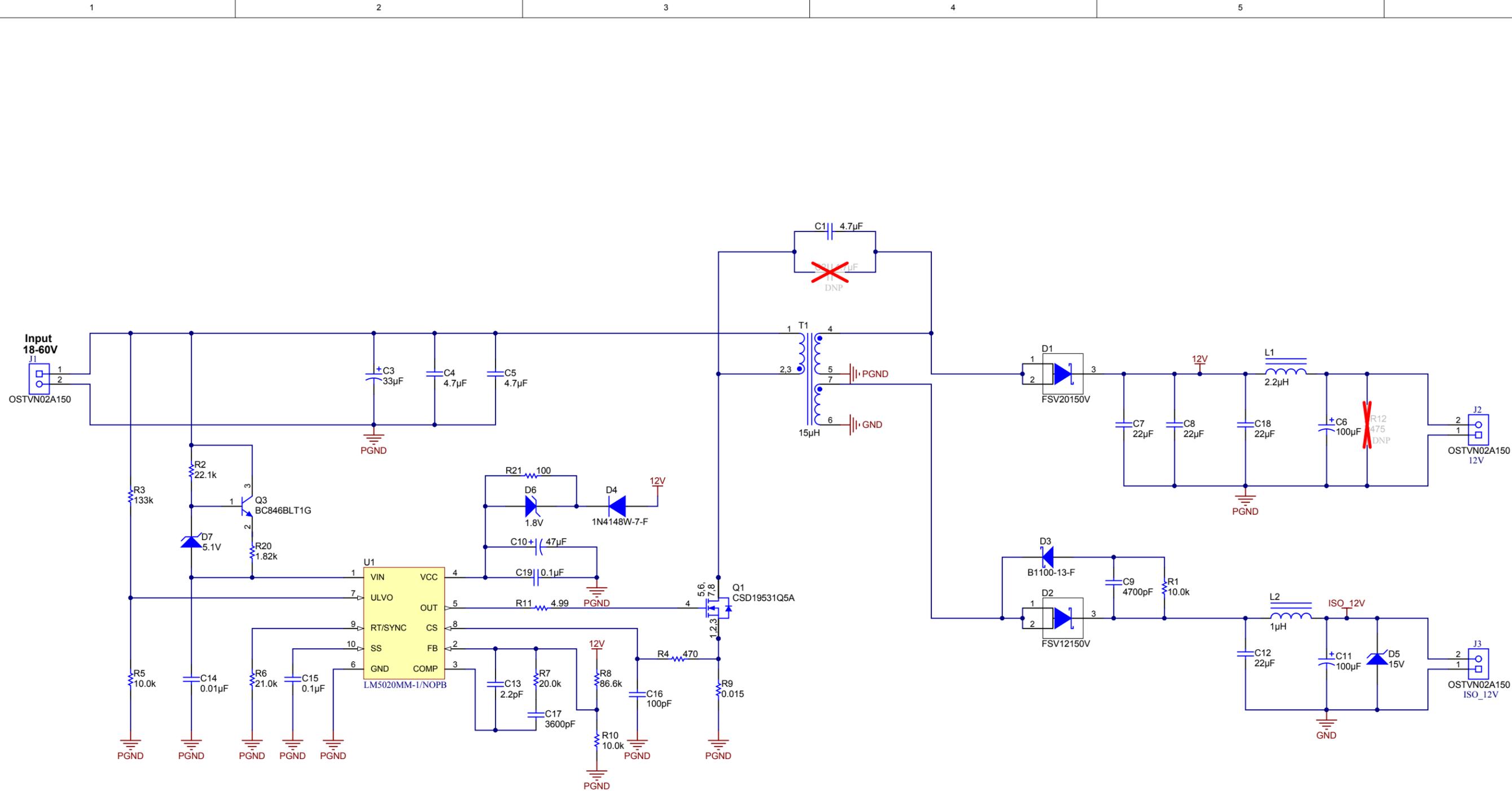
Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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Orderable: N/A	Designed for: Public Release	Mod. Date: 12/9/2016	
TID #: TIDA-00711	Project Title: Low Cost High Eff. Isolated DC-DC Converter	Sheet: 1 of 3	
Number: TIDA-00711	Rev: E1	Assembly Variant: 001	Size: B
SVN Rev: Not in version control	File: TIDA-00711_CoverSheet_SchDoc	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	© Texas Instruments 2016
Drawn By: Aishwarya Natwaya			
Engineer: Aishwarya Natwaya			



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TID #: TIDA-00711	Project Title: Low Cost High Eff. Isolated DC-DC Converter	
Number: TIDA-00711	Rev: E1	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Aishwarya Natwaya	File: TIDA-00711_Sheet1.SchDoc	Size: B
Engineer: Aishwarya Natwaya	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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PCB Number: TIDA-00711  
PCB Rev: E1

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PCB LOGO  
Pb-Free Symbol

PCB LOGO  
Logo3

You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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